# BTM 7740G Trilith IC



THE BTM 774 o G is part of the Trilith IC family containing three dies in one package: One double high-side switch and two low-side switches. The drains of these three vertical DMOS chips are mounted on separated lead frames. The sources are connected to individual pins, so the BTM 7740G can be used in H-bridge- as well as in any other configuration. Both the double high-side and the two low-side switches of the BTM 7740G are manufactured in SMART SIPMOS® technology which combines low  $R_{\rm DSon}$  vertical DMOS power stages with CMOS circuitry for control, protection and diagnosis.

#### **Product Summary**

Туре	Package	Marking
BTM 7740G	PG-DSO-28-22	BTM 7740G

# **Applications**

- Door lock
- Fuel flap lock
- Mirror flap
- Steering wheel lock
- Headrest adjustment
- Various industry applications

#### **Features**

- Quad D-MOS switch driver
- Free configurable as bridge or quad-switch
- Optimized for DC motor management applications
- Low  $R_{DSon}$ High side: 110 mΩ typ. @ 25°C, 270 mΩ max. @ 150°C Low side: 100 mΩ typ. @ 25°C, 230 mΩ max. @ 150°C
- Peak current: typ. 8 A @ 25°C
- Very low quiescent current: typ. 5 μA @ 25°C
- Small outline, enhanced power PG-DSO-package
- Operates up to 40 V
- PWM frequencies up to 1 kHz
- Status flag diagnosis
- Short-circuit-protection
- Overtemperature shut down with hysteresis
- Internal clamp diodes
- Under-voltage detection with hysteresis
- Green product (RoHS compliant)
- AEC qualified

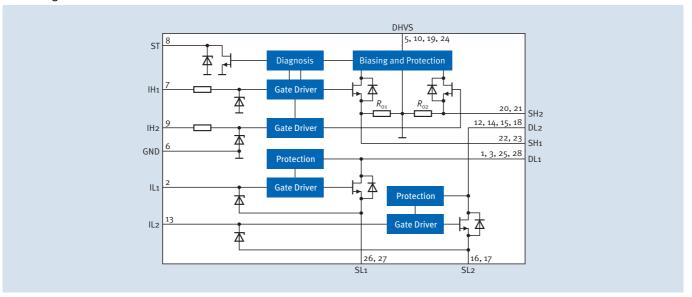
www.infineon.com/trilithic

# **Automotive Power**

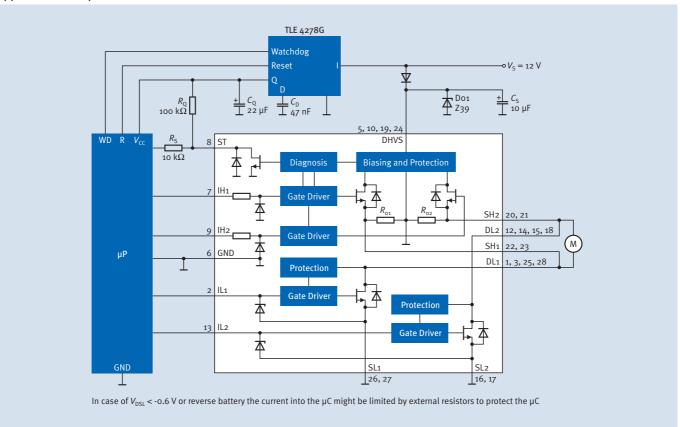


Never stop thinking

### **Block Diagram**



### **Application Example**



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Published by Infineon Technologies AG 81726 Munich, Germany

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